

■ OUTLINE

The R1121N Series are voltage regulator ICs with high output voltage accuracy, extremely low supply current, low ON-resistance and high ripple rejection by CMOS process. Each of these voltage regulator ICs consists of a voltage reference unit, an error amplifier, resistors, a current limit circuit, and a chip enable circuit. These ICs perform with low dropout voltage and a chip enable function.

The line transient response and load transient response of the R1121N Series are excellent, thus these ICs are very suitable for the power supply for hand-held communication equipment.

The output voltage of these ICs is fixed with high accuracy.

Since the package for these ICs are SOT-23-5 (Mini-mold) package, high density mounting of the ICs on boards is possible.

■ FEATURES

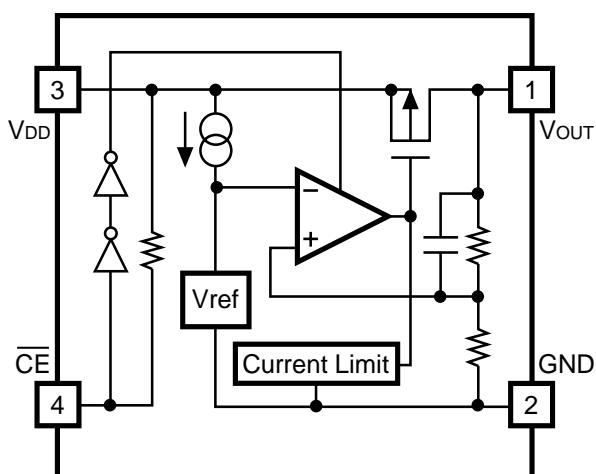
- Ultra-Low Supply Current TYP. 35 μ A
- Standby Mode TYP. 0.1 μ A
- Low Dropout Voltage TYP. 0.2V ($I_{OUT} = 100mA$)
- High Ripple Rejection TYP. 70db ($f = 1kHz$)
- Low Temperature-Drift Coefficient of Output Voltage TYP. $\pm 100ppm/\text{ }^{\circ}\text{C}$
- Excellent Line Regulation TYP. 0.05%/V
- High Accuracy Output Voltage $\pm 2.0\%$
- Small Package SOT-23-5 (Mini-mold)
- Output Voltage Stepwise setting with a step of 0.1V in the range of 1.5V to 5.0V is possible.
- Built-in chip enable circuit (2 Types; A: active "L", B: active "H")
- Pinout Similar to the TK112, TK111

■ APPLICATIONS

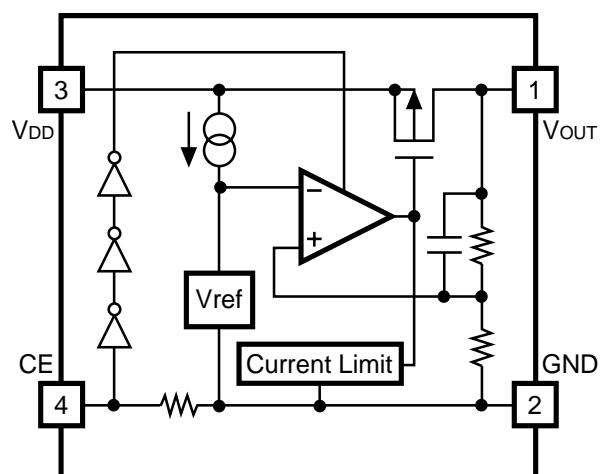
- Power source for cellular phones such as GSM, CDMA and various kind of PCSs.
- Power source for domestic appliances such as cameras, VCRs and camcorders.
- Power source for battery-powered equipment.

■ BLOCK DIAGRAM

R1121NXX1A



R1121NXX1B



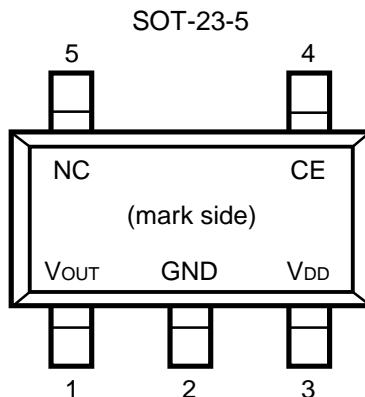
■ SELECTION GUIDE

The output voltage, the active type, and the packing type, and the taping type for the ICs can be selected at the user's request.
The selection can be made by designating the part number as shown below :

R1121XXX1X-XX ←Part Number
↑ ↑ ↑
a b c

Code	Contents
a	Setting Output Voltage (V_{OUT}) : Stepwise setting with a step of 0.1V in the range of 1.5V to 5.0V is possible.
b	Designation of Active Type : A : active "L" type B : active "H" type
c	Designation of Taping Type : Ex. TR, TL (refer to Taping Specifications; TR type is the standard direction.)

■ PIN CONFIGURATION



■ PIN DESCRIPTION

Pin No.	Symbol	Description
1	V_{OUT}	Output pin
2	GND	Ground Pin
3	V_{DD}	Input Pin
4	\overline{CE} or CE	Chip Enable Pin
5	NC	No Connection

■ ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit
V _{IN}	Input Voltage	9	V
V _{CE}	Input Voltage (CE or CE Pin)	-0.3 ~ V _{IN} +0.3	V
V _{OUT}	Output Voltage	-0.3~ V _{IN} +0.3	V
P _D	Power Dissipation	250	mW
Topt	Operating Temperature Range	-40 ~ 85	°C
Tstg	Storage Temperature Range	-55 ~ 125	°C

■ ELECTRICAL CHARACTERISTICS

● R1121NXX1A

Topt = 25°C

Symbol	Item	Conditions	MIN.	TYP.	MAX.	Unit
V _{OUT}	Output Voltage	V _{IN} = Set V _{OUT} +1V 1mA ≤ I _{OUT} ≤ 30mA	V _{OUT} ×0.98		V _{OUT} ×1.02	V
I _{OUT}	Output Current	refer to the ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE				
ΔV _{OUT} /ΔI _{OUT}	Load Regulation	V _{IN} = Set V _{OUT} +1V 1mA ≤ I _{OUT} ≤ 80mA		12	40	mV
V _{DIF}	Dropout Voltage	refer to the ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE				
I _{SS}	Supply Current	V _{IN} = Set V _{OUT} +1V		35	70	μA
I _{standby}	Supply Current (Standby)	V _{IN} = V _{CE} = Set V _{OUT} +1V		0.1	1.0	μA
ΔV _{OUT} /ΔV _{IN}	Line Regulation	Set V _{OUT} +0.5V ≤ V _{IN} ≤ 8V I _{OUT} = 30mA		0.05	0.20	%/V
RR	Ripple Rejection	f = 1KHz, Ripple 0.5Vp-p V _{IN} = Set V _{OUT} +1V		70		dB
V _{IN}	Input Voltage				8	V
ΔV _{OUT} /ΔT	Output Voltage Temperature Coefficient	I _{OUT} = 30mA -40°C ≤ Topt ≤ 85°C		±100		ppm /°C
Ilim	Short Current Limit	V _{OUT} = 0V		50		mA
R _{PU}	CE Pull-up Resistance		2.5	5	10	MΩ
V _{CEH}	CE Input Voltage "H"		1.5		V _{IN}	V
V _{CEL}	CE Input Voltage "L"		0		0.25	V
en	Output Noise	BW = 10Hz ~ 100kHz		30		μVrms

● R1121NXX1B

Topt=25°C

Symbol	Item	Conditions	MIN.	TYP.	MAX.	Unit
V _{OUT}	Output Voltage	V _{IN} = Set V _{OUT} +1V 1mA ≤ I _{OUT} ≤ 30mA	V _{OUT} ×0.98		V _{OUT} ×1.02	V
I _{OUT}	Output Current	refer to the ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE				
ΔV _{OUT} /ΔI _{OUT}	Load Regulation	V _{IN} = Set V _{OUT} +1V 1mA ≤ I _{OUT} ≤ 80mA		12	40	mV
V _{DIF}	Dropout Voltage	refer to the ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE				
I _{SS}	Supply Current	V _{IN} = Set V _{OUT} +1V		35	70	μA
I _{standby}	Supply Current (Standby)	V _{IN} = Set V _{OUT} +1V V _{CE} = GND		0.1	1.0	μA
ΔV _{OUT} /ΔV _{IN}	Line Regulation	Set V _{OUT} +0.5V ≤ V _{IN} ≤ 8V I _{OUT} = 30mA		0.05	0.20	%/V
RR	Ripple Rejection	f = 1KHz, Ripple 0.5Vp-p V _{IN} = Set V _{OUT} +1V		70		dB
V _{IN}	Input Voltage				8	V
ΔV _{OUT} /ΔT	Output Voltage Temperature Coefficient	I _{OUT} = 30mA -40°C ≤ Topt ≤ 85°C		±100		ppm /°C
I _{lim}	Short Current Limit	V _{OUT} = 0V		50		mA
R _{PD}	CE Pull-down Resistance		2.5	5	10	MΩ
V _{CEH}	CE Input Voltage "H"			1.5		V _{IN} V
V _{CEL}	CE Input Voltage "L"			0		0.25 V
en	Output Noise	BW = 10Hz ~ 100kHz		30		μVrms

● ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE

Topt = 25°C

Output Voltage V _{OUT} (V)	Output Current	
	I _{OUT} (mA)	
	Conditions	MIN.
1.5 ≤ V _{OUT} ≤ 1.7		100
1.8 ≤ V _{OUT} ≤ 5.0	V _{IN} - V _{OUT} = 1.0V	150

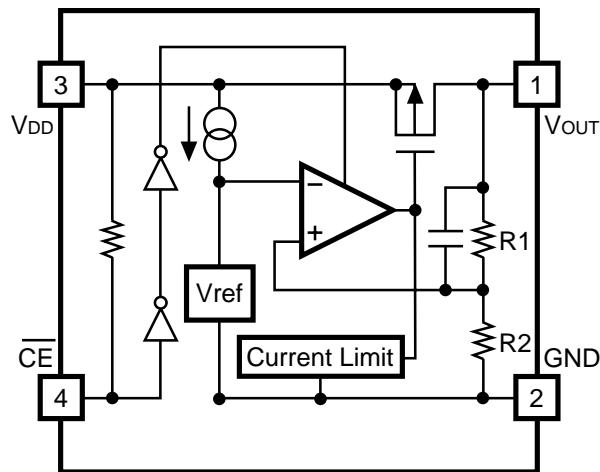
Topt = 25°C

Output Voltage V _{OUT} (V)	Dropout Voltage			
	Conditions	V _{DIF} (V)		
		MIN.	TYP.	MAX.
1.5	I _{OUT} = 100mA	0.5		
1.6		0.4		
1.7		0.3		
1.8 ≤ V _{OUT} ≤ 1.9			0.60	1.40
2.0 ≤ V _{OUT} ≤ 2.4			0.35	0.70
2.5 ≤ V _{OUT} ≤ 2.7			0.24	0.35
2.8 ≤ V _{OUT} ≤ 3.3			0.20	0.30
3.4 ≤ V _{OUT} ≤ 5.0			0.17	0.26

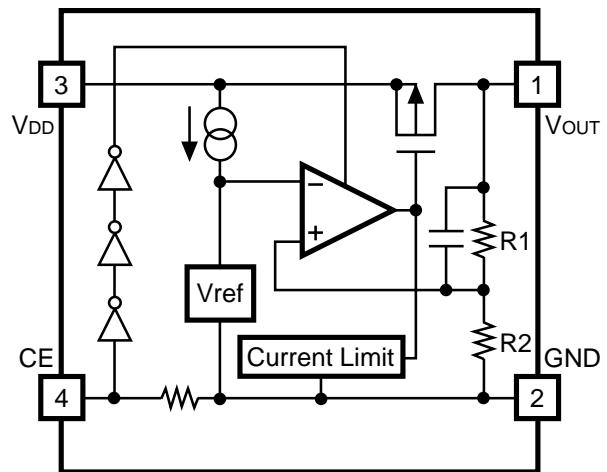
Note : When set Output Voltage is equal or less than 2.0V, VIN should be equal or more than 2.0V.

■ OPERATION

R1121NX1A



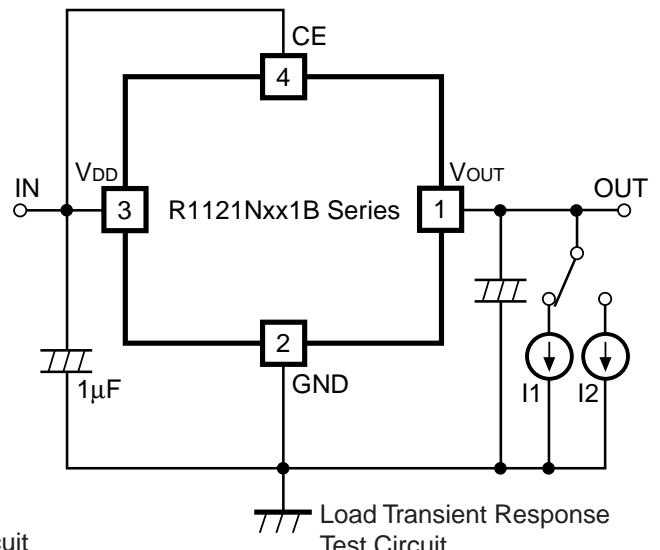
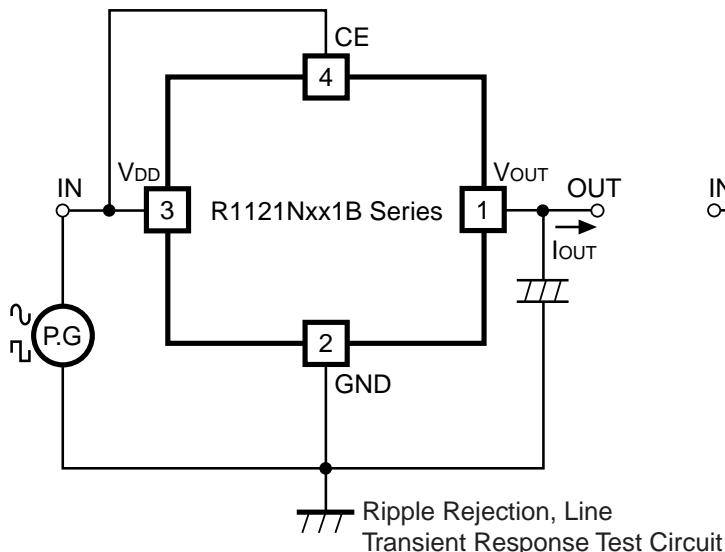
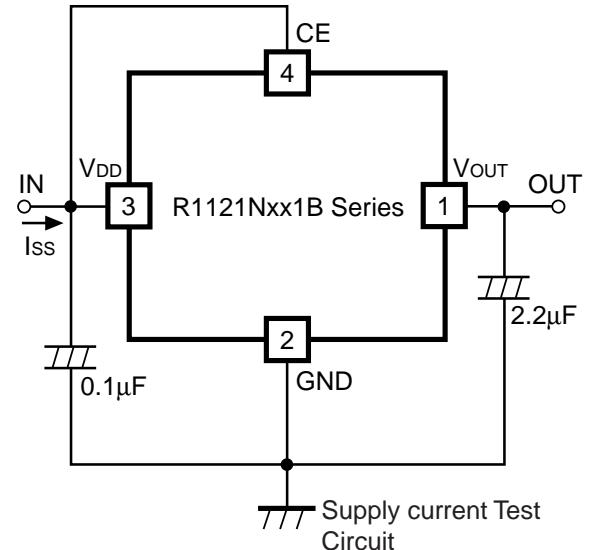
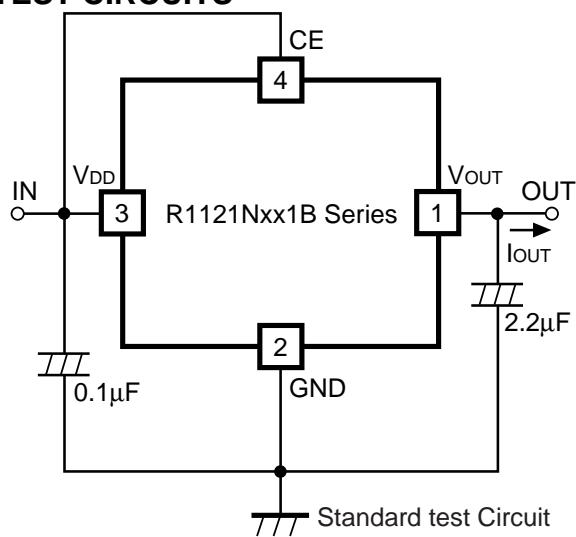
R1121NX1B



In these ICs, fluctuation of Output Voltage, V_{OUT} is detected by Feed-back Registers, R1 and R2, and the result is compared with a reference voltage by Error Amplifier, so that a constant voltage is output.

A current limit circuit for protection at short mode and a chip enable circuit are included.

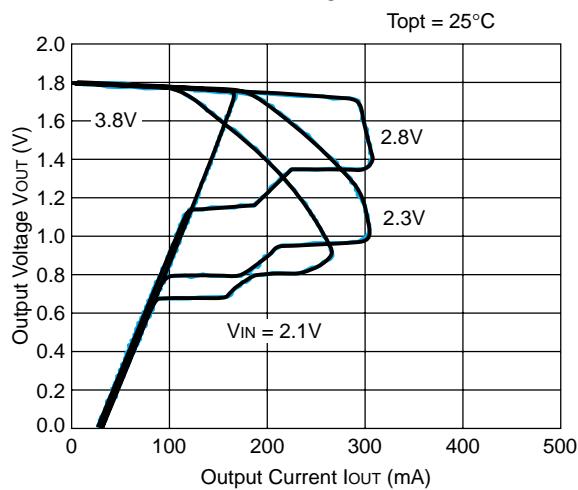
■ TEST CIRCUITS



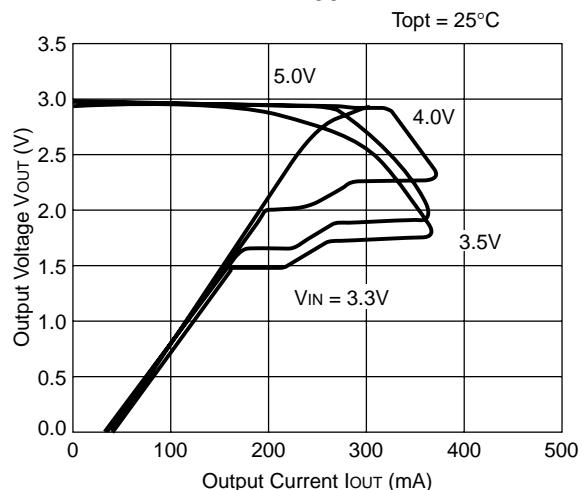
■ TYPICAL CHARACTERISTICS

1) Output Voltage vs. Output Current

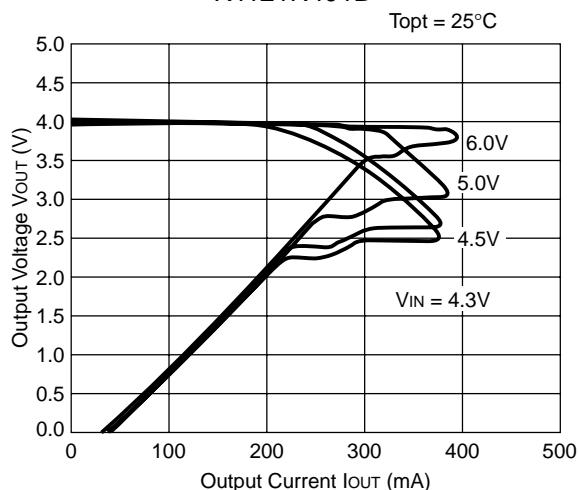
R1121N181B



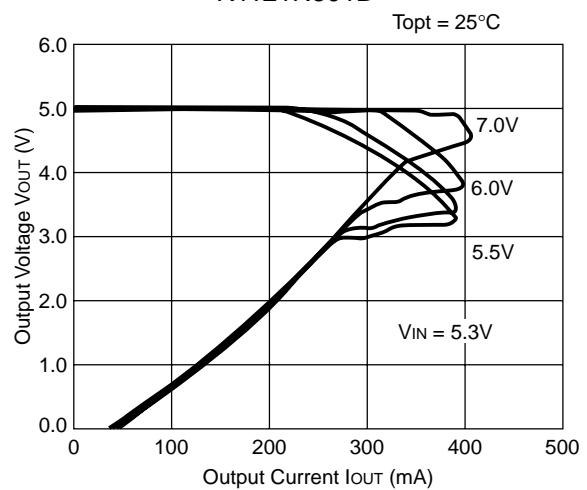
R1121N301B



R1121N401B

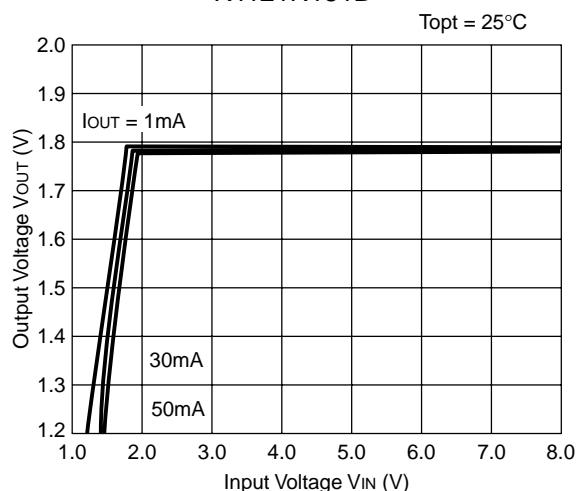


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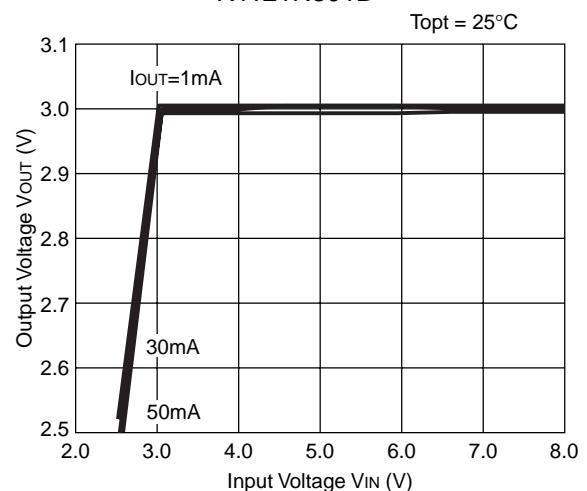


2) Output Voltage vs. Input Voltage

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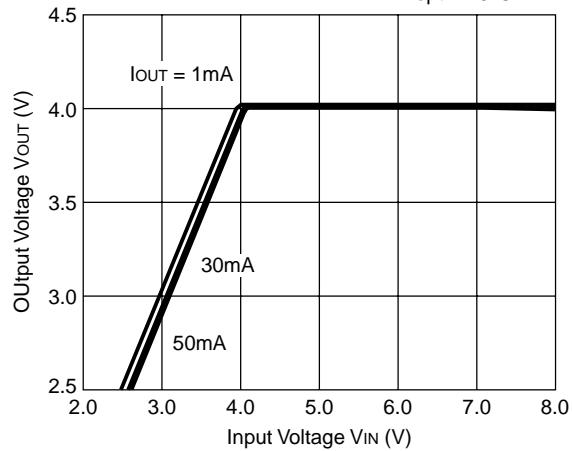


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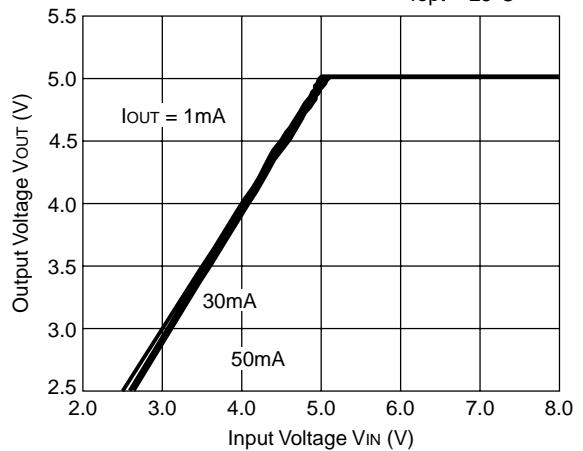
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T_{opt} = 25°C



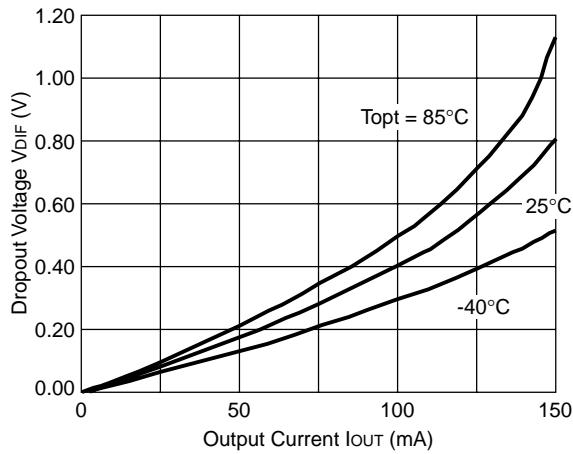
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T_{opt} = 25°C

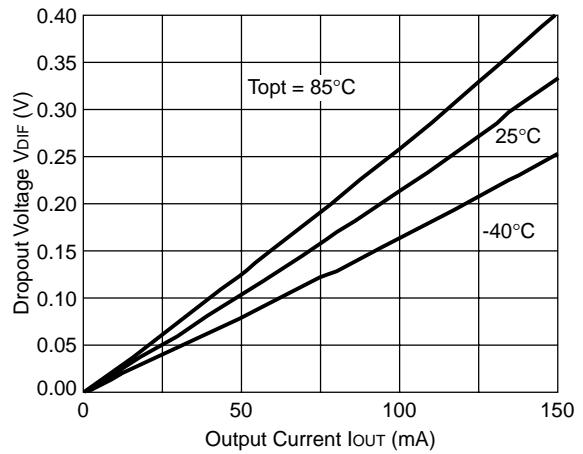


3) Dropout Voltage vs. Output Current

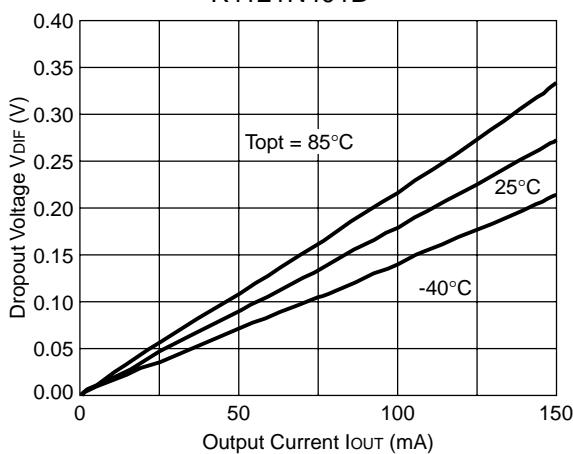
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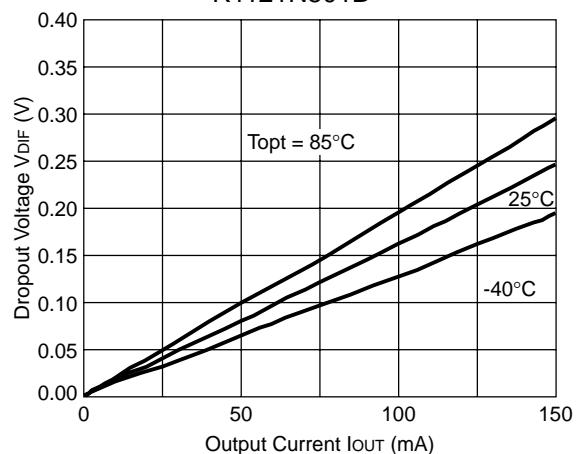
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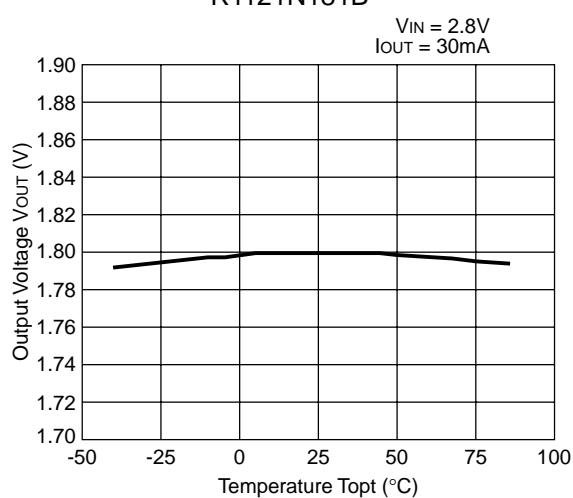
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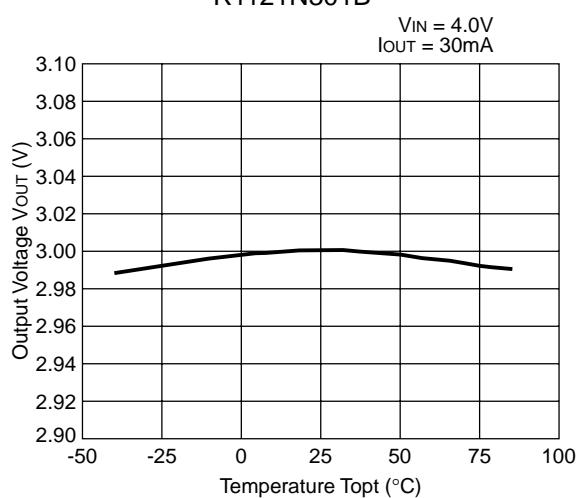
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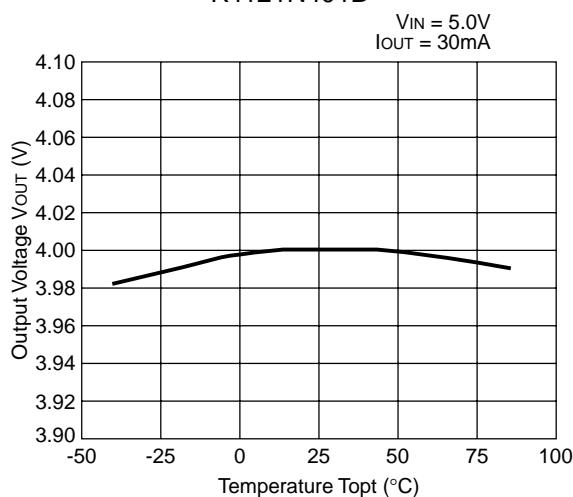
4) Output Voltage vs. Temperature
R1121N181B



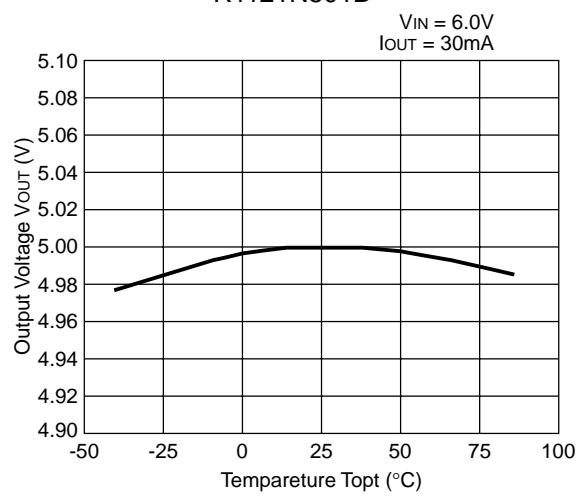
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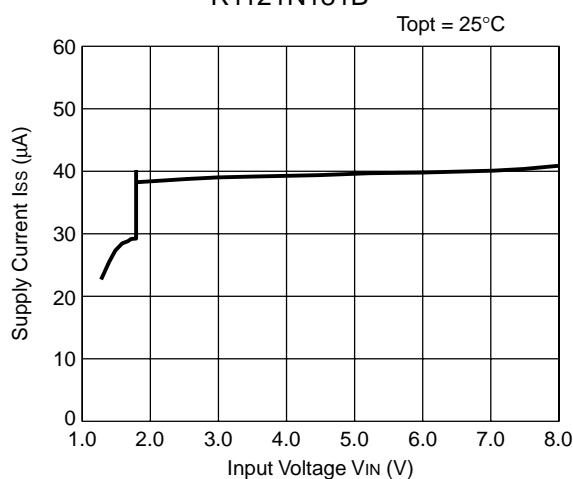
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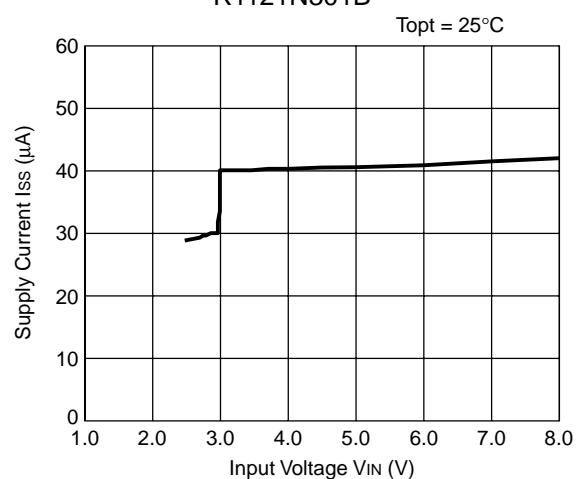
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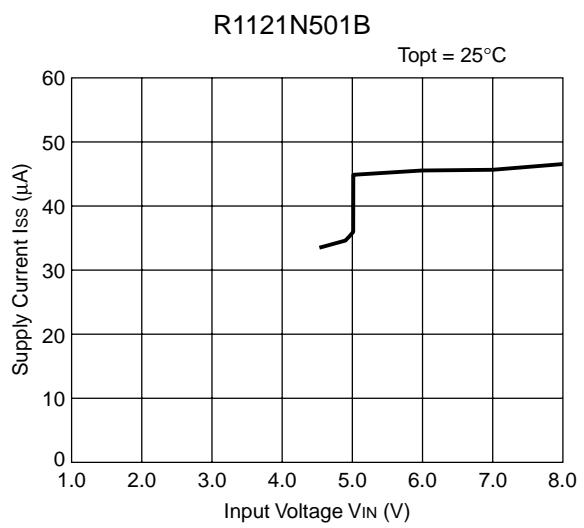
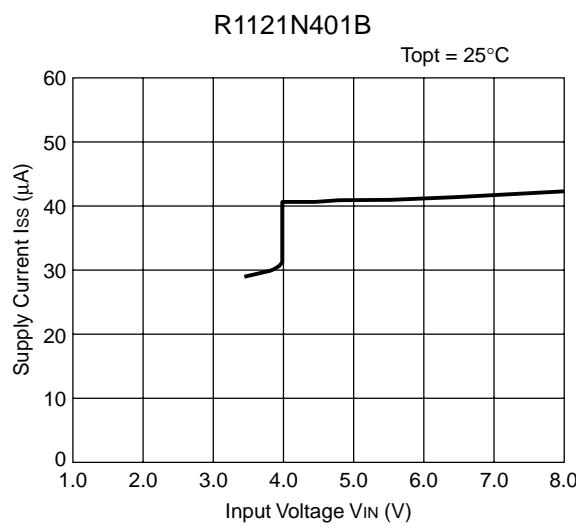


5) Supply Current vs. Input Voltage
R1121N181B

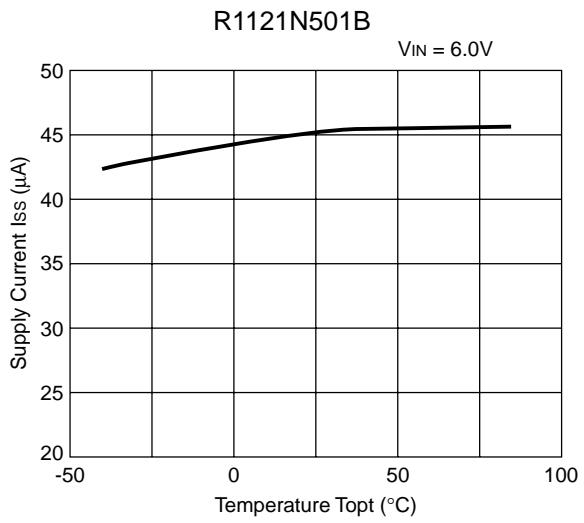
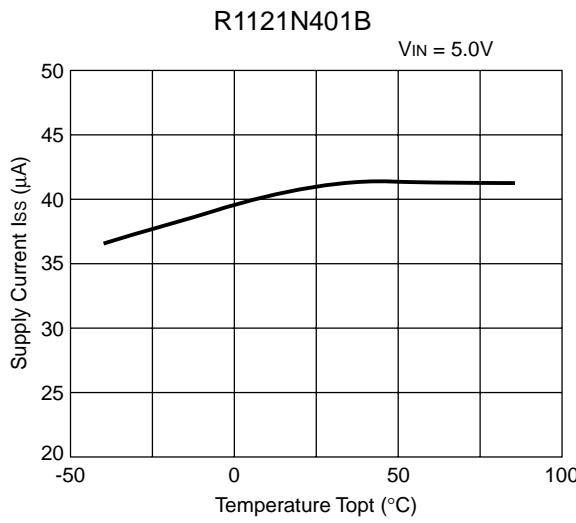
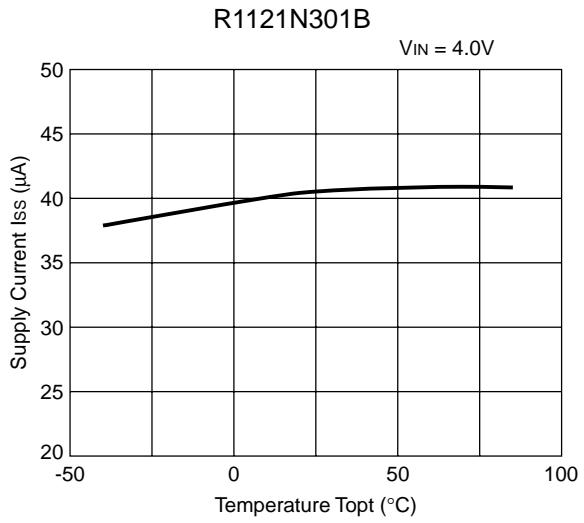
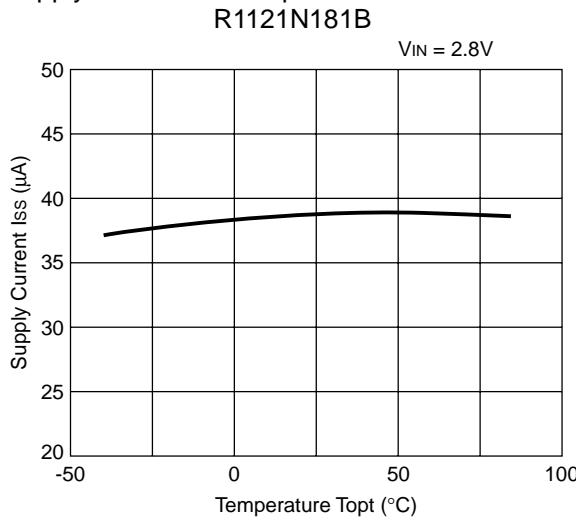


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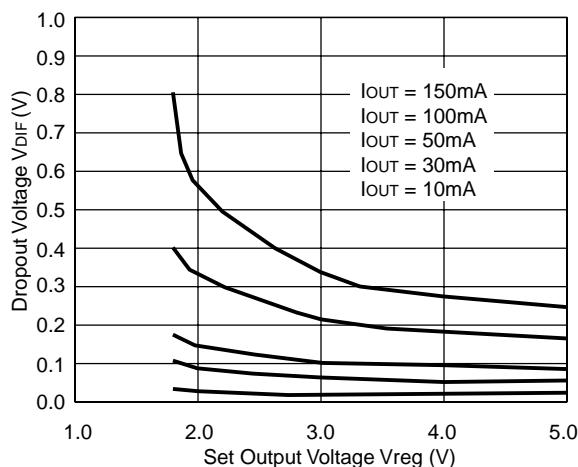
6) Supply Current vs. Temperature



7) Dropout Voltage vs. Set Output Voltage

R1121Nxx1B

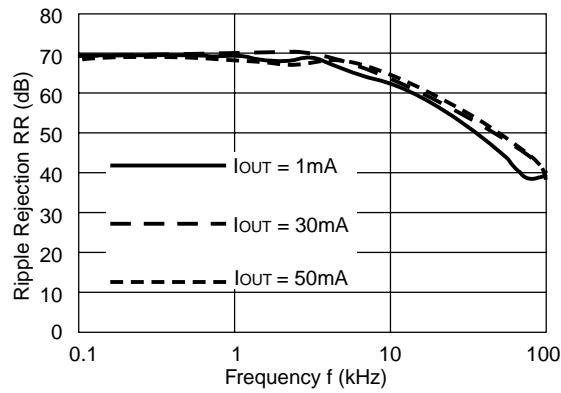
Topt = 25°C



8) Ripple Rejection vs. Frequency

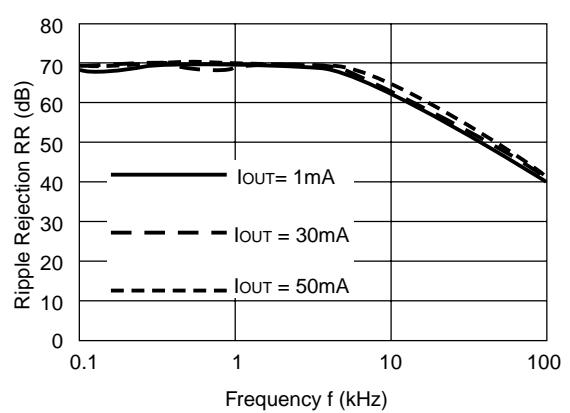
R1121N181B

VIN = 2.8VDC + 0.5Vp-p
COUT = tantal 1.0μF



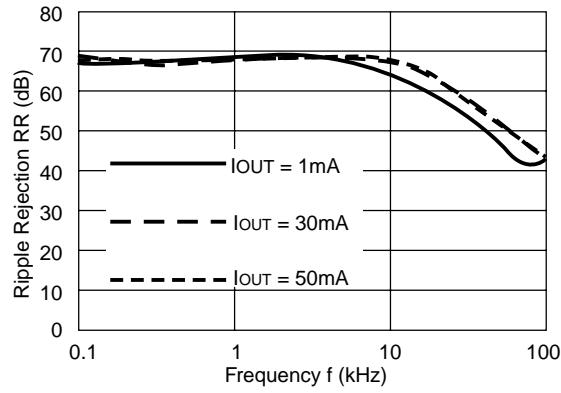
R1121N181B

VIN = 2.8VDC + 0.5Vp-p
COUT = tantal 2.2μF



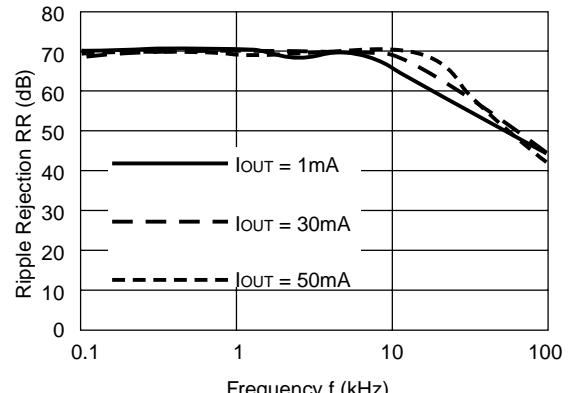
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VIN = 4.0VDC + 0.5Vp-p
COUT = tantal 1.0μF



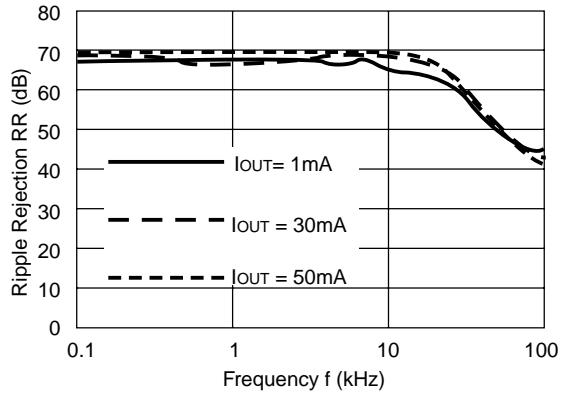
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VIN = 4.0VDC + 0.5Vp-p
COUT = tantal 2.2μF



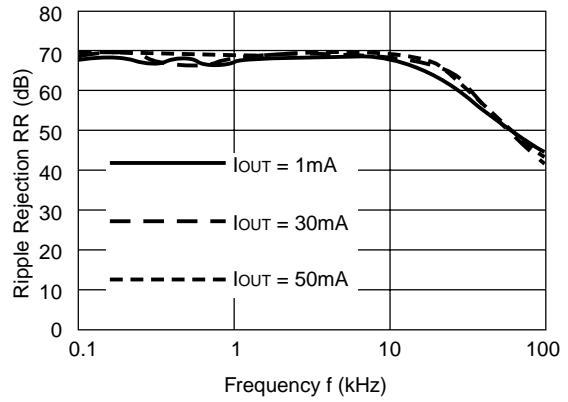
R1121N401B

$V_{IN} = 5.0V_{DC} + 0.5V_{p-p}$
 $C_{OUT} = \text{tantal } 1.0\mu F$



R1121N401B

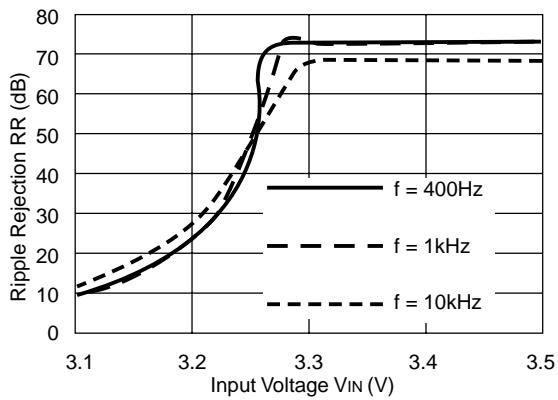
$V_{IN} = 5.0V_{DC} + 0.5V_{p-p}$
 $C_{OUT} = \text{tantal } 2.2\mu F$



9) Ripple Rejection vs. Input Voltage (DC bias)

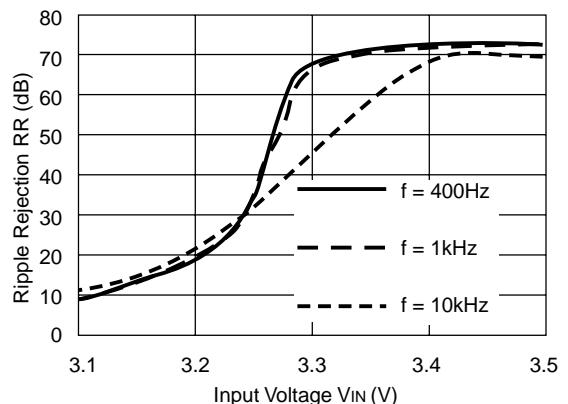
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I_{OUT} = 1mA
 $C_{OUT} = 2.2\mu F$



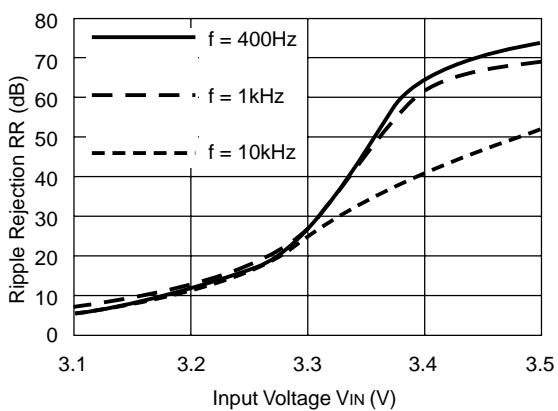
R1121N301B

I_{OUT} = 10mA
 $C_{OUT} = 2.2\mu F$



R1121N301B

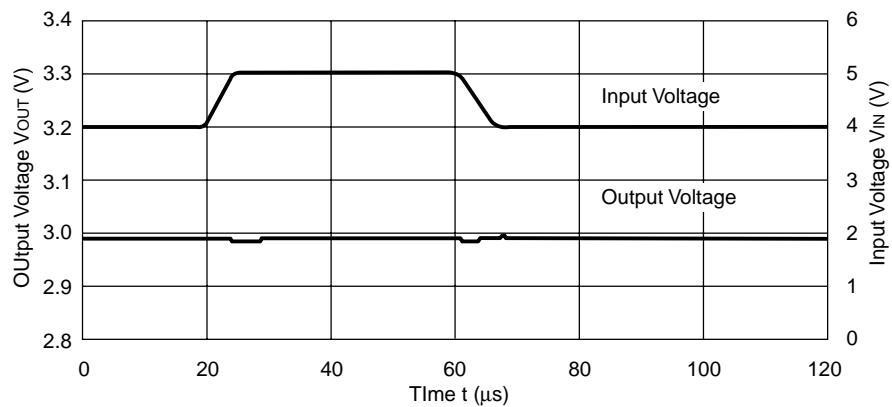
I_{OUT} = 50mA
 $C_{OUT} = 2.2\mu F$



10) Line Transient Response

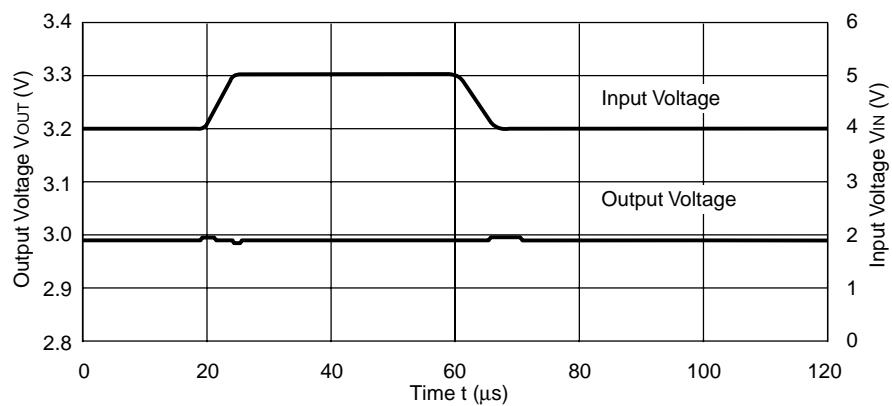
R1121N301B

$I_{OUT}=30mA$
 $t_r=t_f=5\ \mu s$
 $C_{OUT}=\text{Tantalum } 1.0\mu F$



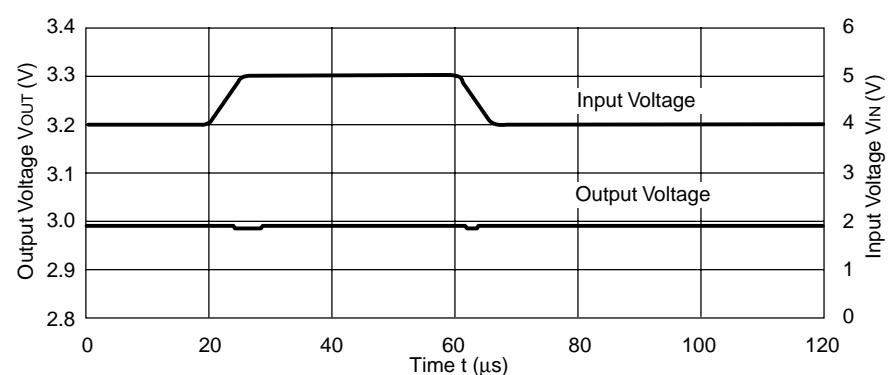
R1121N301B

$I_{OUT}=30mA$
 $t_r=t_f=5\ \mu s$
 $C_{OUT}=\text{Tantalum } 2.2\mu F$



R1121N301B

$I_{OUT}=30mA$
 $t_r=t_f=5\ \mu s$
 $C_{OUT}=\text{Tantalum } 6.8\mu F$

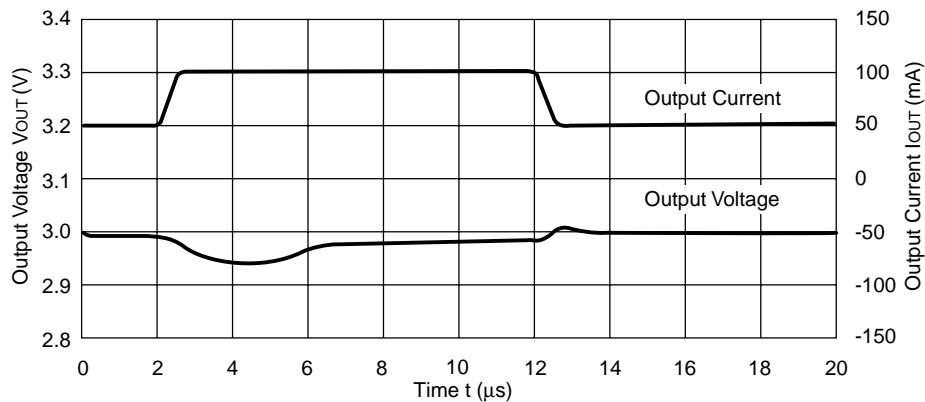


RICOH

11) Load Transient Response

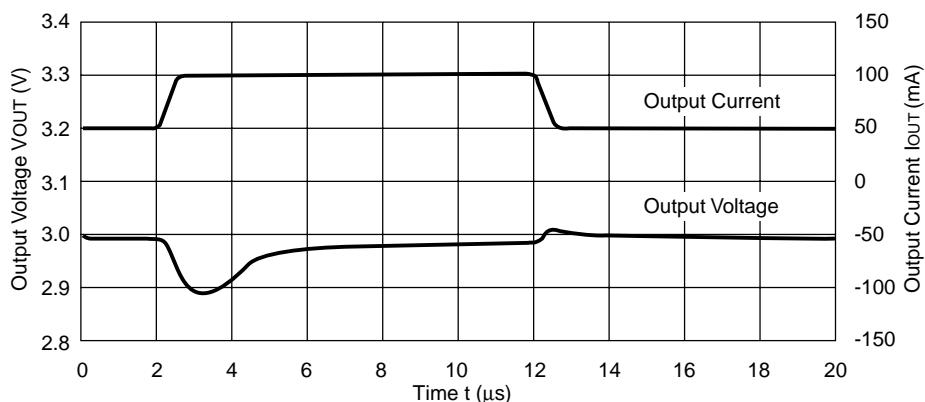
R1121N301B

V_{IN}=4V
C_{IN}=Tantalum 1μF
C_{OUT}=Tantalum 1.0μF



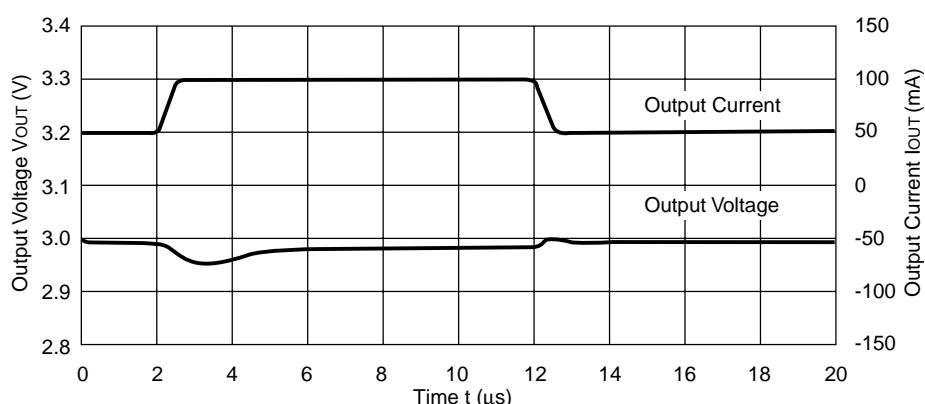
R1121N301B

V_{IN}=4V
C_{IN}=Tantalum 1μF
C_{OUT}=Tantalum 2.2μF



R1121N301B

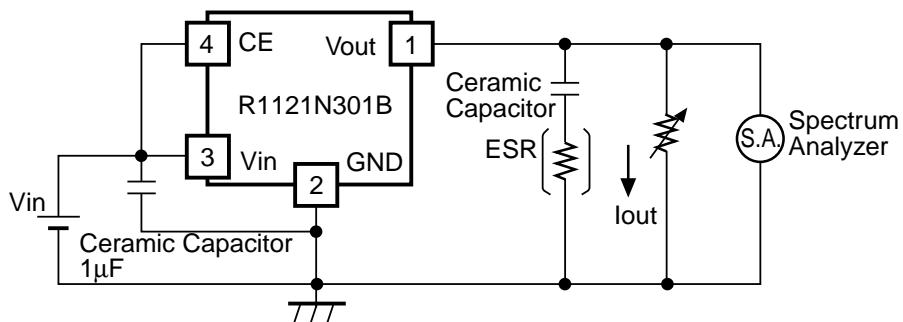
V_{IN}=4V
C_{IN}=Tantalum 1μF
C_{OUT}=Tantalum 6.8μF



■ TECHNICAL NOTES

When using these ICs, be sure to consider following points:

- In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, be sure to use a capacitor C_{OUT} with good frequency characteristics and ESR (Equivalent Series Resistance) of which is in the range described as follows:



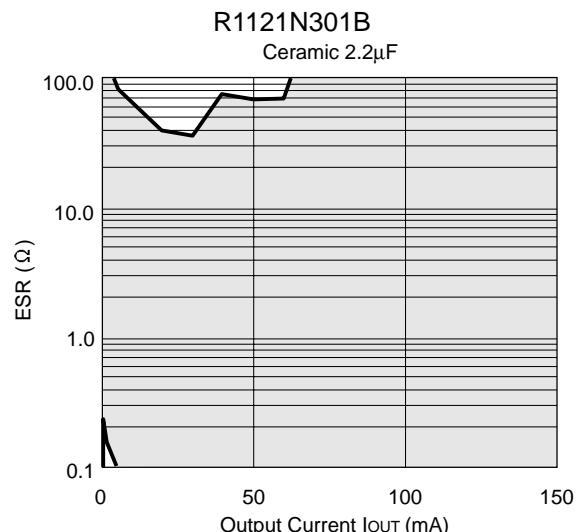
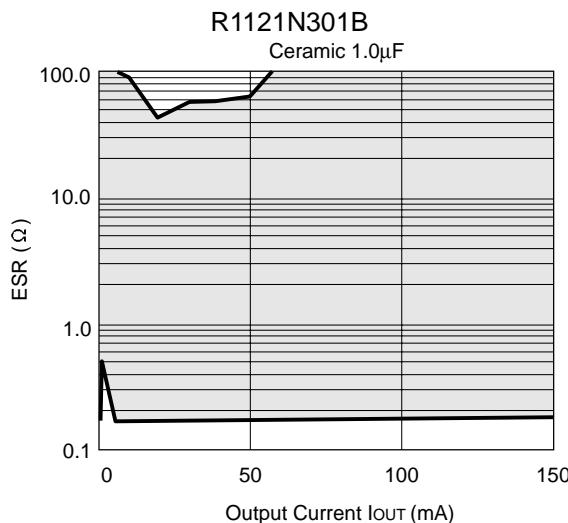
Measuring Circuit for white noise ; R1121N301B

The relations between I_{OUT} (Output Current) and ESR of Output Capacitor are shown below. The conditions when the white noise level is under $40\mu V$ (Avg.) are marked as the hatched area in the graph.

(note: When the additional ceramic capacitors are connected to the Output Pin with Output capacitor for phase compensation, the operation might be unstable. Because of this, test these ICs with as same external components as ones to be used on the PCB.)

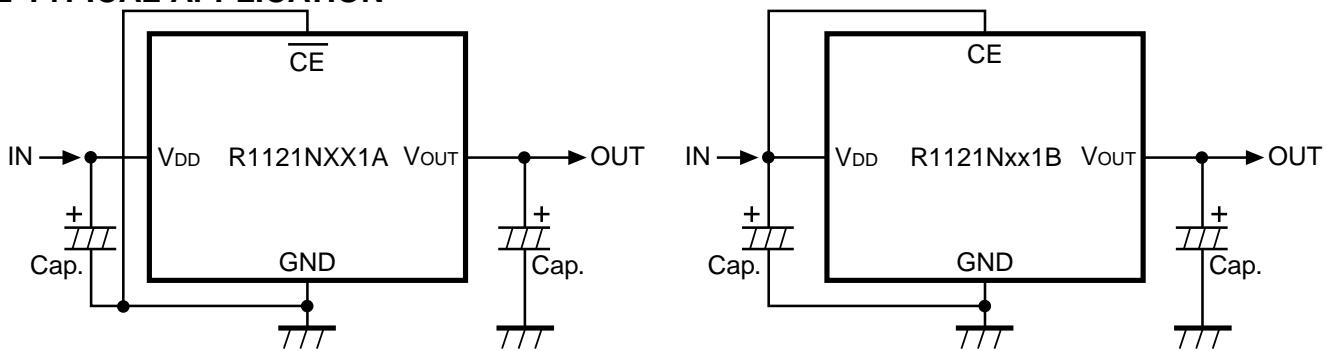
<measuring conditions>

- (1) $V_{IN} = 4V$
- (2) Frequency band :10Hz to 1MHz
- (3) Temperature : $25^{\circ}C$



- Make V_{DD} and GND line sufficient. When the impedance of these is high, there is a case to pick up the noise or not to work correctly.
- Connect the capacitor with a capacitance of $1\mu F$ or more between V_{DD} and GND as close as possible.
- Set external components, especially Output Capacitor, as close as possible to the ICs and make wiring shortest.

■ TYPICAL APPLICATION





Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помошь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помошь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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